

Features

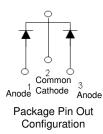
- Ultra Low Forward Voltage Drop
- Low Leakage Current
- Excellent High-Temperature Stability
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- Lead Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Also Available in Green Molding Compound (Note 4)

Mechanical Data

- Case: TO263AB (D²PAK)
- Case Material: Molded Plastic, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 1.6 grams (Approximate)

- Colored Colo

Top View



Ordering Information (Notes 5)

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\sim	Part Number	Case	Packaging
Þ	SBR40U200CTB	TO263AB (D ² PAK)	50 Pieces/Tube
Pb.	SBR40U200CTB-G (Note 4)	TO263AB (D ² PAK)	50 Pieces/Tube
Green	SBR40U200CTB-13	TO263AB (D ² PAK)	800/Tape & Reel
(Ph)	SBR40U200CTB-13-G (Note 4)	TO263AB (D ² PAK)	800/Tape & Reel

TO263AB (D²PAK)

1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For Green Molding Compound version part numbers, add "-G" suffix to part number above. Examples: SBR40U200CTB-G.

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

Notes:



SBR40U200CTB = Product Type Marking Code AB = Foundry and Assembly Code (if applicable) YYWW = Date Code Marking YY = Year (ex: 15 = 2015) WW = Week (01 - 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified)

For capacitance load, derate current by 20%. Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	200	V
Average Rectified Output Current @ T _C = +100°C	lo	40	А
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	240	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance (per leg) Thermal Resistance Junction to Case (Note 6) Thermal Resistance, Junction to Ambient (Note 6)	R _{ejc} R _{eja}	2 7	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +175	°C

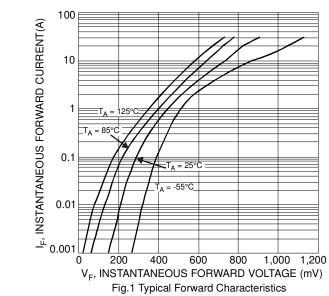
Electrical Characteristics (@T_A = +25°C unless, otherwise specified)

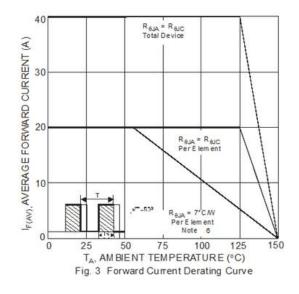
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop (per leg)	VF	-	0.85 0.70	0.93 0.75	V	I _F = 20A, T _J = +25°C I _F = 20A, T _J = +125°C
Leakage Current (Note 7)	I _R		-	0.2 40	mA	V _R = 200V, T _J =+25°C V _R = 200V, T _J = +125°C
Reverse Recovery Time		-	38	50	nS	I _F = 0.5A, I _R = 1A, I _{RR} = 0.25A
neverse necovery fille	۱rr	-	25	35		$I_F = 1A, V_R = 30V$ di/dt = 100A/µs, T _J = +25°C

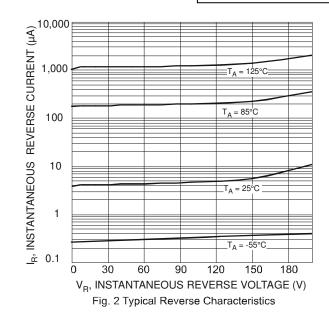
6. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.7. Short duration pulse test used to minimize self-heating effect. Notes:



SBR40U200CTB



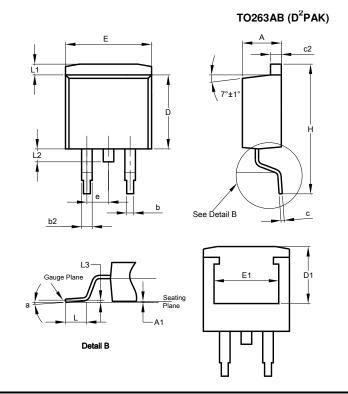






Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

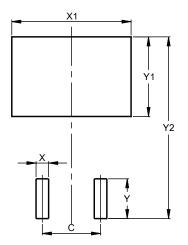


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TO263AB (D ² PAK)					
Dim	Min	Max	Тур		
Α	4.07	4.82	-		
A1	0.00	0.25	-		
b	0.51	0.99	-		
b2	1.15	1.77	-		
С	0.356	0.73	-		
c2	1.143	1.65	-		
D	8.39	9.65	-		
D1	6.55	6.95	-		
е		2.54 TYP			
Е	9.66	-			
E1	6.23	8.23	-		
Н	14.61	15.87	-		
L	1.78	2.79	-		
L1	-	1.67	-		
L2	-	1.77	-		
L3	-	-	0.254		
а	0°	8°	-		
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

TO263AB (D²PAK)



Dimensions	Value (in mm)
С	5.08
Х	1.10
X1	10.41
Y	3.50
Y1	7.01
Y2	15.99



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